

<b>ENGINEERING DEPT.</b>		<b>PRODUCT SPECIFICATION</b> <b>For CF09 Series Connector System</b>	<b>SPEC.NO.: SPCF011G</b>
<b>REVISIONS</b>	<b>ECN11064</b>		<b>PAGE: 1/3</b>

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and inserted on the specified size FFC and FPC

2. APPLICABLE STANDARDS:

MIL - STD - 202	Methods for test of connectors for electronic equipment
MIL - STD - 1344	Test methods for electrical connectors
SS-00254	Test methods for electronic components ,LEAD-FREE soldering Part design standards

3. APPLICABLE SERIES NO.: **CF09 Series**

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")  
6.2 P.C. Board Layout: See attached drawings

7. ACCOMMODATED FPC/FFC THICKNESS

0.3 +0.04/-0.01 mm (.012+.002/-0")



REVIEWED : David APPROVED : Eisley VERIFIED : Sandy .

<b>ENGINEERING DEPT.</b>		<b>PRODUCT SPECIFICATION</b> <b>For CF09 Series Connector System</b>	<b>SPEC.NO.: SPCF011G</b>
<b>REVISIONS</b>	<b>ECN11064</b>		<b>PAGE: 2/3</b>

**8. ELECTRICAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Rated current and voltage		1A max. 100V AC/DC max.
8.2	Contact resistance	Dry circuit of DC 20 mV max. , 100 mA max.	Less than 20 mΩ
8.3	Dielectric strength	When applied AC 500 V 1 minute between adjacent terminal	No change
8.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 500 MΩ

**9. MECHANICAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Contact retaining force in insulator	Retention speed 25± 3 mm per minute from housing	More than 0.5 Kgf
9.2	FFC / FPC withdrawal force (Reference data)	Measure force to withdrawal using 0.30 mm thickness FPC / FFC at speed 25± 3 mm per minute	40× no. of Contacts gram min.
9.3	Durability	Connector shall be subjected to 5 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial

**10. ENVIRONMENTAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
10.1	Temperature rise	Then carried the rated current	30°C max.
10.2	Vibration	1.5 mm 10-55-10 HZ / minute each 2 hours for X , Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.

<b>ENGINEERING DEPT.</b>		<b>PRODUCT SPECIFICATION</b> <b>For CF09 Series Connector System</b>	<b>SPEC.NO.: SPCF011G</b>
<b>REVISIONS</b>	<b>ECN11064</b>		<b>PAGE: 3/3</b>

10.3	Solder ability	<b>Tin-Lead Process :</b> Soldering time: 5 ± 0.5 second Soldering pot: 230 ± 5°C <b>Lead-Free Process :</b> Soldering time: 3 ± 0.5 second Soldering pot: 245 ± 5°C	Minimum: 90% of immersed area
10.4	Resistance to soldering heat	<b>Tin-Lead Process</b> Soldering time: 5 ± 0.5 second Soldering pot: 240 ± 5°C <b>Lead-Free Process :</b> Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage
10.5	Heat aging	85 ± 2°C , 96 hours	No damage
10.6	Humidity	40 ± 2°C , 90-95% RH , 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 8-3
10.7	Temperature cycling	One cycle consists of : (1) -55 <sup>+0</sup> <sub>-3</sub> °C , 30 min. (2) Room temp. 10-15 min. (3) 85 <sup>+3</sup> <sub>-0</sub> °C , 30 min. (4) Room temp. 10-15 min.	Appearance: No damage Contact resistance: Less than twice of initial
10.8	Salt spray	Temperature: 35 ± 3°C Solution: 5 ± 1% Spray time: 48 ± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

11. AMBIENT TEMPERATURE RANGE: -25 to + 85°C